



U.S. Express Mail No.: EU265089285US  
Attorney Docket No.: AM-5256-2

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

IN RE APPLICATION OF: Jeng H. Hwang et al.

SERIAL NO.: 09/747,667

FILED: December 22, 2000

FOR: PLASMA HEATING OF A SUBSTRATE WITH  
SUBSEQUENT HIGH TEMPERATURE ETCHING

§ GROUP ART UNIT: 1765

§  
§ EXAMINER: S. Ahmed

§  
§ Attorney Docket No.:  
§ AM-5256-2

Date: July 23, 2003

**AMENDMENT "B" UNDER 37 CFR § 1.116**

**Hon. Commissioner for Patents  
P.O. Box 1450  
Alexandria, Virginia 22313-1450**

Sir:

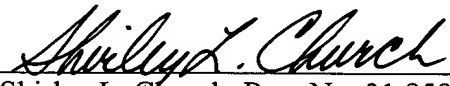
This Amendment "B" is in response to the final Office Action mailed May 23, 2003, having a shortened statutory period for response of August 23, 2003. This Amendment "B" is being submitted within two (2) months of the mailing date of the Final Rejection, to permit time for an Advisory Action.

Claims 1 - 57 are pending in the application.

**CERTIFICATE OF MAILING UNDER 37 CFR § 1.10**

I hereby certify that this paper is being deposited with the U.S. Postal Service on the date shown below with sufficient postage as U.S. EXPRESS MAIL NO. EU265089285US in an envelope addressed to: Mail Stop AF, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

Date: July 23, 2003

  
Shirley L. Church, Reg. No. 31,858

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Claims 1 - 57 are rejected under 35 USC § 103(a) as being unpatentable over U.S. Patent No. 6,323,132, to Hwang et al., in view of U.S. Patent No. 6,094,334, to Bedi et al.

Please amend the application as follows: